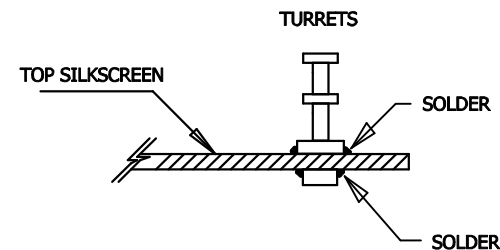



NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 deg C.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
5. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
6. TEST POINTS (2PLCS) SHOULD BE FREE OF SOLDER.



APPROVALS		 <div> 1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL - FOR CUSTOMER USE ONLY </div>	
PCB DES.			
APP ENG.		TITLE: TOP ASSEMBLY DRAWING 2-STRING, 2MHz STEP-UP LED DRIVER WITH $\pm 1.8\%$ CURRENT MATCHING	
		SIZE N/A	IC NO. LT3909EDD <div style="text-align: right;">DC2176A</div>
SCALE = NONE		FILENAME: 2176A-Rev3.PCB	REV. 3
		SHT 1 OF 1	